

12500 TI Boulevard, MS 8640, Dallas, Texas 75243

PCN# 20141104001 ISO7241C Data Sheet Data Sheet Change Notification

Date: 11/20/2014 To: Newark/Farnell PCN

Dear Customer:

This is a notice of change to a product data sheet for a device that is currently offered by Texas Instruments. The details of this change are on the following pages.

We request you acknowledge receipt of this notification within **30** days of the date of this notice.

The proposed first ship date is indicated on page 3 of this notification, unless customer agreement has been reached on an earlier implementation of the change.

This notice does not change the end-of-life status of any product. Should product affected be on a previously issued product withdrawal/discontinuance notice, this notification does not extend the life of that product or change the life time buy offering/discontinuance plan.

For questions regarding this notice, contact your local Field Sales Representative or the PCN Manager (<u>PCN ww admin team@list.ti.com</u>).

Sincerely,

PCN Team SC Business Services Phone: +1(214) 480-6037 Fax: +1(214) 480-6659

20141104001 Attachment: 1

Products Affected:

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

DEVICE

ISO7241CDW

CUSTOMER PART NUMBER

null

Technical details of this Product Change follow on the next page(s).

PCN Number:		20141104001						PCN Date: 11/20/2014			
Title: ISO7241C Da			ata Sheet								
Custome	Customer Contact: PCN Manage		Phone:		+1(214)480-6037		Dept:	Dept: Quality Service			
Proposed 1 st Ship Da		te:								•	
Change 1	ype:										
Assembly Site					Design			Wafer Bump Site		o Site	
Assembly Process					Data Sheet			Wafer	Wafer Bump Material		
Assembly Materials			5		Part number change				Wafer Bump Process		
Mechanical Specifica					Test Site				Wafer Fab Site		
Packing/Shipping/Labeling			ling	Test Process				Wafer Fab Materials			
<u> </u>								Wafer	Wafer Fab Process		
					PCN I	Details					
	Description of Change: The product datasheet(s) for ISO7241C have been updated as summarized in the following								- II		
		(S) TO	r ISO/2	410	_ nave be	en updated as s	umm	narized ir	i the i	rollowing	
change hi	story.										
TEVAS											
ISO7240CF, ISO7240C, ISO7240M											
ISO7241C, ISO7241M, ISO7242C, ISO7242M											
SLLS868P – SEPTEMBER 2007 – REVISED OCTOBER 2014 www.ti.com											
Changes from Revision O (November 2012) to Revision P Page											
Added Pin Configuration and Functions section, Handling Rating table, Feature Description section, Device											
Functional Modes, Application and Implementation section, Power Supply Recommendations section, Layout											
-	section, Device and Documentation Support section, and Mechanical, Packaging, and Orderable Information										
section											
Changed ISO7241C minimum supply from 2.8 V to 3.15 V											
The datas	heet number	will I	be chan	ging].						
Device F				Change From: Change To:				nge To:			
IS07241	С		SL	LS8680 SLLS				S868P	868P		
These changes may be reviewed at the datasheet links provided.											
http://www.ti.com/lit/gpn/iso7241c											
Reason for Change:											
To more accurately reflect device characteristics.											
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):											
Electrical specification performance changes as indicated above.											
Changes to product identification resulting from this PCN:											
None.											
Product	Affected:										
IS07241	CDW	IS	072410	DW	DWG4 ISO7241CDWR ISO7241CDWRG4						

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com